

Simulation based optimisation of energy efficiency in data centres

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Trade-off relationships between energy consumptions by cooling & IT devices in DC

- Two major energy consumers in DCs: cooling and IT devices
- Higher temperature may reduce the energy consumption by cooling devices but may • also decrease energy efficiencies of IT devices
- Lack of understanding of the dynamics caused by cooling, IT devices, workloads • and temperature controls
 - EnergyConsumption (Coolers) = f (Temperature)
 - EnergyConsumption (IT devices) = q (Temperature)
 - Temperature = h (workloads)



Recent works

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- Estimate power consumption of a DC
 - Ham et al. (2015) estimate DC power consumption using very simple server model
 - T_{die}: temperature of a CPU which measured from the server directly



- Other studies use simpler models than Ham et al. (2015)'s
 - Choo et al. (2017) estimate power consumption of cooling systems only
 - Bash & Forman (2007) conduct experiments to shutdown servers if they have finished workload that received.
 - Cho and Kim (2016) suggest optimal cooling strategies using dedicated cooling systems based on the assumption that IT devices use energy homogeneously regardless the variances of workloads.

Research gap (1)

- No studies done for power consumption of a server based on workload and inflow and exit air temperature
 - Recent servers and CPUs have functions if the temperature is higher than is expected in normal, it limit speed of CPU and servers



- If the temperature of inflow air and exit air and the fan speed are known, then we can calculate how much heat has been removed
- Prior studies estimate energy consumption by devices through CPU activities and ignore other components.
- Calculating the temperature difference between in and out air flows can reflect activities of all components including CPUs of IT devices.

Research gap (2)

- Since each server does not have a dedicated cooler, temperature of inflow air is different.
 - As we can see in the simulated result below, each server's temperature is different due to relative location from coolers and the working status of coolers
 - If we distribute workloads for servers within various locations, the perceived temperature of a server (inflow air temperature of a server) can affect its performance.



Research Questions

- Does high temperature inflow air affect energy consumption of the server for given workload?
- Does a server located between two air-conditioner performs more efficiently than a server located in the side (or behind other servers)?
- How energy efficiency of coolers and servers are affected as temperature increases (or decreases)?
- What are the best rules for activating coolers and IT devices for a given workloads?

Target devices to be installed: Server room

- Target server groups (racks): two racks in the left server room
 - Two server racks (gray location in the below picture)
 - One rack is one of the closest positions to air conditioners, the other is a farthest location
 - Four SmartPDU it is configured for two racks due to redundant power supply



Target devices to be installed: Rack

- To install sensors aligned with server location
 - Due to installation feasibility, sensors are installed on the rack / not on the server directly
 - Install inflow/exit temperature sensors aligned with specific servers (the top/middle/bottom server)
 - Six sensors will be installed front and rear of each server rack



Data collection solutions (suggested by Turksat)

- Every sensor and equipment will be connected to a server using SNMP card
 - SNMP card send monitoring values to the target hosts
 - It will be stored using monitoring software such as Zabbix / SolarWinds

Target Equipment	Measuring equipment	# of equipment	Measurement	Status
Sensors	Server racks Air conditioners	12 for server racks 6 for air conditioners	Temperature Humidity	To be installed
Energy meter	Power consumption	3 for air conditioners 3 for chillers	Power consumption	To be installed
SmartPDU	Equipment installed in the server racks	4 for server racks	Power consumption	To be installed
UPS	UPS itself	2 UPS	Power consumption of UPS	Installed
Chiller	Chiller itself	3 Chillers	Outside air temperature	Installed

Measurement variables and specification^{16 February 2019}

Variables	Description	Target Equipment	Measure Equipment	Install location	Unit	Decimal places	Measure Frequency	DB	Comment
In _{Temp}	Inflow air temperature	Rack/2	Temperature Sensor	Rack	°C	2	1 sec (realtime)	DCIM	Synchronize recording time with WL
In _H	Inflow air humidity	Rack/2	Temperature Sensor	Rack	%	2	1 sec (realtime)	DCIM	Use the same sensor with In _{Temp}
Out _{Temp}	Exit air temperature	Rack/2	Temperature Sensor	Rack	°C	2	1 sec (realtime)	DCIM	Synchronize recording time with WL
Server _{Fan}	Fan speed of the server	Server/6	On board sensor	Installed	RPM	0	Use system report value	Zabbix	Synchronize recording time with WL
CPU _{Vol}	Input voltage of CPUs	Server/6	On board sensor	Installed	V	2	Use system report value	Zabbix	Measure for each CPU
CPU_{temp}	Temperature of CPUs	Server/6	On board sensor	Installed	°C	2	Use system report value	Zabbix	Measure for each CPU
WL	Workload	Server/6	Zabbix	Zabbix	%	2	Use system report value	Zabbix	
$Rack_{pc}$	Power consumption	Rack/2	PDU	installed	kW	2	1 sec (realtime)	New db or Zabbix	Total power consumption of PDU
Server _{PC}	Power consumption	Server/6	PDU	Installed	kW	2	1 sec (realtime)	New db or Zabbix	Synchronize recording time with WL
$CRAC_{temp}$	Air temperature from AC	Air conditioner	Temperature Sensor	Front of air inlet	°C	2	1 sec (realtime)	New db or Zabbix	Synchronize recording time with WL
CRAC _H	Air humidity from AC	Air conditioner	Temperature Sensor	Front of air inlet	%	2	1 sec (realtime)	New db or Zabbix	Use the same sensor with InT
$CRAC_{pc}$	Power consumption	Air conditioner	Power meter (?)	Power cord (?)	kW	2	1 sec (realtime)	New db or Zabbix	Synchronize recording time with WL
Ch_{Temp}	Ambient outside temperature	Chiller	Built-in (Available)	Front of air inlet	°C	2	1 sec (realtime)	New db or Zabbix	Synchronize recording time with WL
Ch _{PC}	Power consumption	Chiller	Power meter (?)	Power cord (?)	kW	2	1 sec (realtime)	New db or Zabbix	Synchronize recording time with WL
UPS_{pc}	Power consumption	UPS	Built-in (available)		kW	2	1 sec (realtime)	Zabbix	Synchronize recording time with WL

Simple analysis model

- Temperature data (InT, OutT, and Ct) and power consumption data (Pc and Cp) have correlation between each other
- Workload data is given at specific server and time. But workload processing can be affected by other conditions and vice versa
- To deal with endogenous variables (temperature and power consumption), we use panel vector auto regression (PVAR) model as a base model

$$\begin{bmatrix} Pc_{i,t} \\ Cp_{i,t} \\ InT_{i,t} \\ WL_{i,t} \\ OutT_{i,t} \\ CT_{i,t} \end{bmatrix} = \sum_{j=1}^{J} \begin{bmatrix} \phi_{1,j}^{i,j} & \phi_{1,6}^{i,j} \\ \phi_{2,1}^{i,j} & \phi_{2,6}^{i,j} \\ \phi_{3,1}^{i,j} & \phi_{3,6}^{i,j} \\ \phi_{3,1}^{i,j} & \cdots & \phi_{3,6}^{i,j} \\ \phi_{4,1}^{i,j} & \phi_{4,6}^{i,j} \\ \phi_{5,1}^{i,j} & \phi_{5,6}^{i,j} \\ \phi_{5,1}^{i,j} & \phi_{5,6}^{i,j} \\ \phi_{6,1}^{i,j} & \phi_{6,6}^{i,j} \end{bmatrix} \begin{bmatrix} Pc_{i,t-j} \\ Cp_{i,t-j} \\ InT_{i,t-j} \\ WL_{i,t} \\ OutT_{i,t-j} \\ CT_{i,t-j} \end{bmatrix} + ControlVars + Const + \varepsilon_{i,j-1}$$

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